MBRS410LT3

Preferred Device

Surface Mount Schottky Power Rectifier

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "ORing" of multiple supply voltages and any other application where performance and size are critical.

Features

- Ultra Low V_F
- 1st in the Market Place with a 10 V_R Schottky Rectifier
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard–Ring for Stress Protection
- Pb–Free Package is Available

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C
 - Human Body Model = 3B

MAXIMUM RATINGS

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August, 2005 - Rev.

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	10	V
Average Rectified Forward Current (@ T _L = 110°C)	Ι _Ο	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A
Operating Junction Temperature	TJ	-65 to +125	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



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SCHOTTKY BARRIER RECTIFIERS 4.0 AMPERES, 10 VOLTS



SMC CASE 403 PLASTIC

MARKING DIAGRAM



B4L1	= Specific Device Code
А	= Assembly Location
Y	= Year
WW	= Work Week
•	= Pb-Free Package
(Note: M	licrodot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRS410LT3	SMC	2500/Tape & Reel
MBRS410LT3G	SMC (Pb–Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

BDTIC.com/ON^{Publication Order Number:} MBRS410LT3/D

THERMAL CHARACTERISTICS

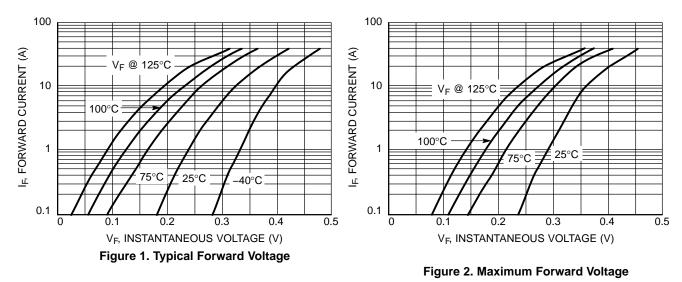
Characteristic	Symbol	Min Pad (Note 2)	1 Inch Pad	Unit
Thermal Resistance,				°C/W
Junction-to-Lead	$R_{\theta JL}$	12	7.0	
Thermal Resistance,				
Junction-to-Ambient	R_{\thetaJA}	109	59	

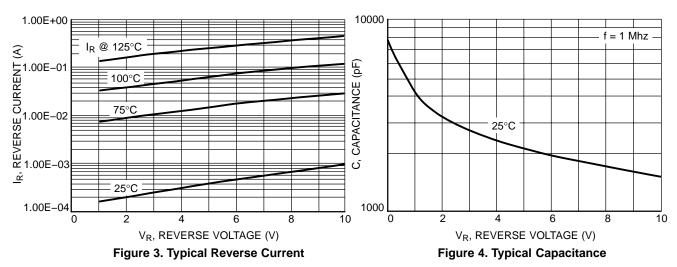
ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1)	V _F	T _J = 25°C	T _J = 100°C	V
$(I_F = 2.0 \text{ A})$ $(I_F = 4.0 \text{ A})$ $(I_F = 8.0 \text{ A})$		0.31 0.33 0.35	0.200 0.225 0.250	
Maximum Instantaneous Reverse Current (Note 1)	I _R	T _J = 25°C	T _J = 100°C	mA
(Rated dc Voltage, $V_R = 5.0 \text{ V}$) (Rated dc Voltage, $V_R = 10 \text{ V}$)		2.0 5.0	100 200	

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

2. Mounted with Minimum Recommended Pad Size, PC Board FR4.





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MBRS410LT3

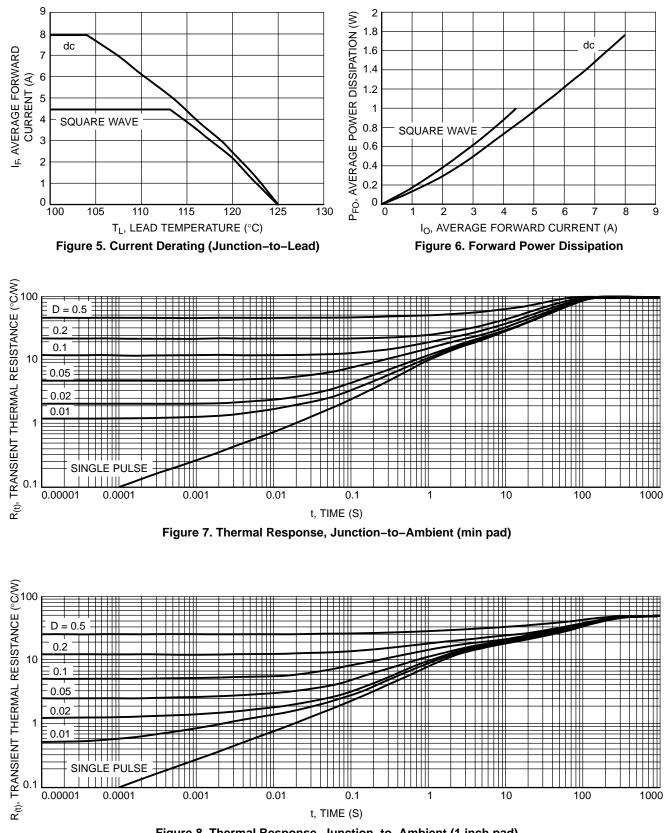


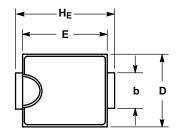
Figure 8. Thermal Response, Junction-to-Ambient (1 inch pad)

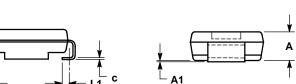
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MBRS410LT3

PACKAGE DIMENSIONS

SMC PLASTIC PACKAGE CASE 403–03 ISSUE E





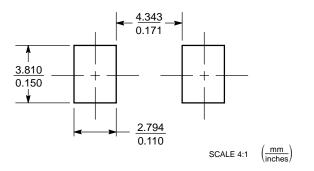
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

4. 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.90	2.13	2.41	0.075	0.084	0.095
A1	0.05	0.10	0.15	0.002	0.004	0.006
b	2.92	3.00	3.07	0.115	0.118	0.121
С	0.15	0.23	0.30	0.006	0.009	0.012
D	5.59	5.84	6.10	0.220	0.230	0.240
E	6.60	6.86	7.11	0.260	0.270	0.280
HE	7.75	7.94	8.13	0.305	0.313	0.320
L	0.76	1.02	1.27	0.030	0.040	0.050
L1	0.51 REF				0.020 REF	

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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